

SATA Slim

3ME2 Series

Customer: _____

Customer

Part

Number: _____

Innodisk

Part

Number: _____

Innodisk

Model Name: _____

Date: _____

Innodisk Approver	Customer Approver

Table of contents

LIST OF FIGURES	6
1. PRODUCT OVERVIEW	7
1.1 INTRODUCTION OF INNODISK SATA SLIM 3ME2	7
1.2 PRODUCT VIEW AND MODELS	7
1.3 SATA INTERFACE.....	8
1.4 CAPACITY	8
1.5 MO-297 FORM FACTOR.....	8
2. PRODUCT SPECIFICATIONS	9
2.1 CAPACITY AND DEVICE PARAMETERS.....	9
2.2 PERFORMANCE	9
2.3 ELECTRICAL SPECIFICATIONS	10
2.3.1 Power Requirement.....	10
2.3.2 Power Consumption	10
2.4 ENVIRONMENTAL SPECIFICATIONS	10
2.4.1 Temperature Ranges	10
2.4.2 Humidity.....	10
2.4.3 Shock and Vibration	10
2.4.4 Mean Time between Failures (MTBF)	10
2.5 CE AND FCC COMPATIBILITY	11
2.6 RoHS COMPLIANCE	11
2.7 RELIABILITY	11
2.8 TRANSFER MODE	11
2.9 PIN ASSIGNMENT	12
2.10 MECHANICAL DIMENSIONS.....	13
2.11 ASSEMBLY WEIGHT	13
2.12 SEEK TIME	13
2.13 HOT PLUG.....	13
2.14 NAND FLASH MEMORY.....	13
3. THEORY OF OPERATION.....	14
3.1 OVERVIEW.....	14
3.2 SATA III CONTROLLER	14
3.3 ERROR DETECTION AND CORRECTION.....	15
3.4 WEAR-LEVELING	15
3.5 BAD BLOCKS MANAGEMENT	15
3.6 iDATA GUARD.....	15
3.7 GARBAGE COLLECTION/TRIM	15
4. INSTALLATION REQUIREMENTS	16

4.1 SATA SLIM 3ME2 PIN DIRECTIONS.....	16
4.2 ELECTRICAL CONNECTIONS FOR SATA SLIM 3ME2	16
4.3 DEVICE DRIVE	16
5. PART NUMBER RULE	17

REVISION HISTORY

Revision	Description	Date
Preliminary	First Released	Feb., 2015
Rev 1.0	1. Update TBW 2. Add CE/FCC report	Mar., 2015
Rev 1.1	Update performance	Mar., 2015
Rev 1.2	Add 32GB Information	May, 2015
Rev 1.3	Update performance	May, 2015
Rev 2.0	Add Toshiba 15nm	Aug., 2016

List of Tables

TABLE 1: DEVICE PARAMETERS.....	9
TABLE 2: PERFORMANCE	9
TABLE 3: INNODISK SATA SLIM 3ME2 POWER REQUIREMENT.....	10
TABLE 4: POWER CONSUMPTION	10
TABLE 5: TEMPERATURE RANGE FOR SATA SLIM 3ME2.....	10
TABLE 6: SHOCK/VIBRATION TESTING FOR SATA SLIM 3ME2.....	10
TABLE 7: SATA SLIM 3ME2 MTBF	11
TABLE 8: INNODISK SATA SLIM 3ME2 PIN ASSIGNMENT.....	12

List of Figures

FIGURE 1: INNODISK SATA SLIM 3ME2	7
FIGURE 2: INNODISK SATA SLIM 3ME2 BLOCK DIAGRAM.....	14
FIGURE 3: SIGNAL SEGMENT AND POWER SEGMENT.....	16

1. Product Overview

1.1 Introduction of Innodisk SATA Slim 3ME2

Innodisk SATA Slim 3ME2 provides a totally brand new highly cost-effective SSD solution with good performance and longer lifespan. SATA Slim 3ME2 is a perfect substitute for traditional HDD, which are applied with an evolved L² Wear Leveling Architecture, and significantly improves SSD random data transfer rate and lifespan. Furthermore, SATA Slim 3ME2 supports TRIM for windows 7, it can improves performance when deleting files.

SATA Slim 3ME2 provides high capacity flash memory within JEDEC MO-297 spec., which electrically compatible with Serial ATA (SATA) standard, and supports SATA III standard (6.0GHz) with high performance. It has good performance; no latency time and small seek time. It effectively reduces the booting time of operation system and the power consumption is less than hard disk drive (HDD).

1.2 Product View and Models

Innodisk SATA Slim 3ME2 is available in follow capacities within MLC flash ICs.

SATA Slim 8GB	SATA Slim 3ME2 32GB	SATA Slim 3ME2 128GB
SATA Slim 16GB	SATA Slim 3ME2 64GB	SATA Slim 3ME2 256GB



Figure 1: Innodisk SATA Slim 3ME2

1.3 SATA Interface

SATA Slim 3ME2 supports SATA III interface, and backward compliant with Serial ATA Gen 1, Gen 2 and Gen 3 specification (Gen 3 supports 1.5Gbps /3.0Gbps/6.0Gbps data rate)..

1.4 Capacity

Innodisk SATA Slim 3ME2 provides unformatted 8GB, 16GB, 32GB, 64GB, 128GB, and 256GB capacities within MLC Flash IC.

1.5 MO-297 Form Factor

SATA Slim 3ME2 has a compact design 54.0mm (W) x 39.0mm (L) x 4.0mm (H) without metal material case, and is easy for installation.

2. Product Specifications

2.1 Capacity and Device Parameters

SATA Slim 3ME2 device parameters are shown in Table 1.

Table 1: Device parameters

Capacity	LBA	Cylinders	Heads	Sectors	User Capacity(MB)
8GB	15649200	15255	16	63	7,641
16GB	31277232	16383	16	63	15,272
32GB	62533296	16383	16	63	30533
64GB	125045424	16383	16	63	61057
128GB	250069680	16383	16	63	122104
256GB	500118192	16383	16	63	244198

2.2 Performance

Burst Transfer Rate: 6.0Gbps

Table 2: Performance

	Capacity	32GB	64GB	128GB	256GB
Micron L95	Sequential Read (max.)	220 MB/s	440 MB/s	440 MB/s	440 MB/s
	Sequential Write (max.)	40 MB/s	80 MB/s	160 MB/s	160 MB/s
	4KB Random Read (QD32)	1,000 IOPS	21,000 IOPS	30,000 IOPS	29,000 IOPS
	4KB Random Write (QD32)	1,000 IOPS	21,000 IOPS	40,000 IOPS	39,000 IOPS

	Capacity	8GB	16GB	32GB	64GB	128GB	256GB
Toshiba 15nm	Sequential Read (max.)	140 MB/s	140 MB/s	280 MB/s	500 MB/s	510 MB/s	510 MB/s
	Sequential Write (max.)	25 MB/s	25 MB/s	50 MB/s	100 MB/s	190 MB/s	330 MB/s
	4KB Random Read (QD32)	7,300 IOPS	6,800 IOPS	13,700 IOPS	26,000 IOPS	32,900 IOPS	34,500 IOPS
	4KB Random Write (QD32)	3,800 IOPS	3,600 IOPS	10,200 IOPS	24,000 IOPS	47,600 IOPS	47,000 IOPS

Note: Based on CrystalDiskMark 3.03 with file size 1000MB

2.3 Electrical Specifications

2.3.1 Power Requirement

Table 3: Innodisk SATA Slim 3ME2 Power Requirement

Item	Symbol	Rating	Unit
Input voltage	V _{IN}	+5 DC +/- 5%	V

2.3.2 Power Consumption

Table 4: Power Consumption

Mode	Power Consumption
Read	225 mA (max.)
Write	335 mA (max.)
Idle	61 mA (max.)
DEVS LP Mode	3mW (min.)
Slumber Mode	30mW (min.)

* Target: SATA Slim 3ME2 256GB (Micron L95)

2.4 Environmental Specifications

2.4.1 Temperature Ranges

Table 5: Temperature range for SATA Slim 3ME2

Temperature	Range
Operating	Standard Grade: 0°C to +70°C
	Industrial Grade:-40°C to +85°C
Storage	-55°C to +95°C

2.4.2 Humidity

Relative Humidity: 10-95%, non-condensing

2.4.3 Shock and Vibration

Table 6: Shock/Vibration Testing for SATA Slim 3ME2

Reliability	Test Conditions	Reference Standards
Vibration	7 Hz to 2K Hz, 20G, 3 axes	IEC 68-2-6
Mechanical Shock	Duration: 0.5ms, 1500 G, 3 axes	IEC 68-2-27

2.4.4 Mean Time between Failures (MTBF)

Table 7 summarizes the MTBF prediction results for various SATA Slim 3ME2 configurations. The analysis was performed using a RAM Commander™ failure rate prediction.

- **Failure Rate:** The total number of failures within an item population, divided by the total

number of life units expended by that population, during a particular measurement interval under stated condition.

- Mean Time between Failures (MTBF):** A basic measure of reliability for repairable items: The mean number of life units during which all parts of the item perform within their specified limits, during a particular measurement interval under stated conditions.

Table 7: SATA Slim 3ME2 MTBF

Product	Condition	MTBF (Hours)
Innodisk SATA Slim 3ME2	Telcordia SR-332 GB, 25°C	>3,000,000

2.5 CE and FCC Compatibility

SATA Slim 3ME2 conforms to CE and FCC requirements.

2.6 RoHS Compliance

SATA Slim 3ME2 is fully compliant with RoHS directive.

2.7 Reliability

Parameter	Value
Read Cycles	Unlimited Read Cycles
Wear-Leveling Algorithm	Support
Bad Blocks Management	Support
Error Correct Code	Support
iData Guard	Support
Thermal Sensor	Support
TBW* (Total Bytes Written)	Unit: TB
8GB	2.3
16GB	4.7
32GB	9.6
64GB	19.2
128GB	38.4
256GB	76.8
* Total bytes written is based on JEDEC 218 (Solid-State Drive Requirements and Endurance Test Method)	
** Lifespan is calculated by device written per day	

2.8 Transfer Mode

SATA Slim 3ME2 support following transfer mode:

Serial ATA III 6.0Gbps

Serial ATA II 3.0Gbps

Serial ATA I 1.5Gbps

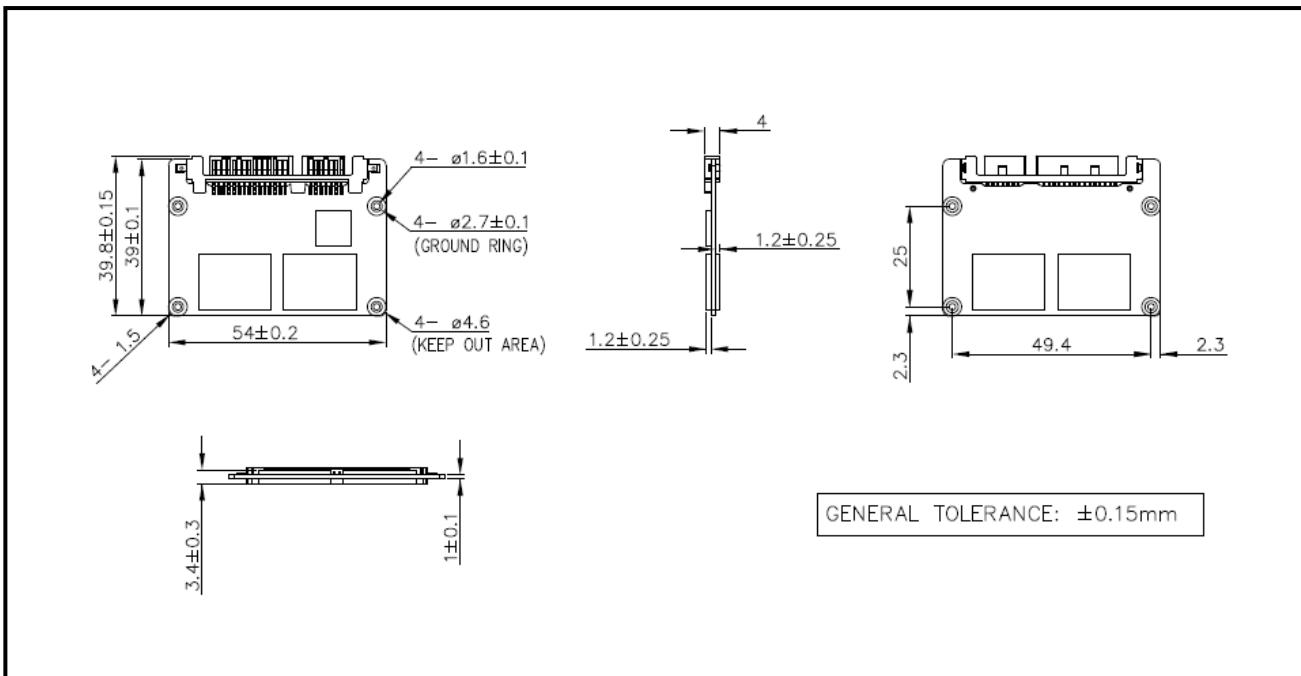
2.9 Pin Assignment

Innodisk SATA Slim 3ME2 uses a standard SATA pin-out. See Table 8 for SATA Slim 3ME2 pin assignment.

Table 8: Innodisk SATA Slim 3ME2 Pin Assignment

Name	Type	Description
S1	GND	NA
S2	A+	Differential Signal Pair A
S3	A-	
S4	GND	NA
S5	B-	Differential Signal Pair B
S6	B+	
S7	GND	NA
Key and Spacing separate signal and power segments		
P1	NC	NA
P2	NC	NA
P3	NC	NA
P4	GND	NA
P5	GND	NA
P6	GND	NA
P7	V5	5V Power, Pre-Charge
P8	V5	5V Power
P9	V5	5V Power
P10	GND	NA
P11	DAS/DSS	Device Activity Signal / Disable Staggered
P12	GND	NA
P13	NC	NA
P14	NC	NA
P15	NC	NA

2.10 Mechanical Dimensions



2.11 Assembly Weight

An Innodisk SATA Slim 3ME2 within MLC flash ICs, 32GB's weight is 40 grams approx. The total weight of SSD will be less than 50 grams.

2.12 Seek Time

Innodisk SATA Slim 3ME2 is not a magnetic rotating design. There is no seek or rotational latency required.

2.13 Hot Plug

The SSD support hot plug function and can be removed or plugged-in during operation. User has to avoid hot plugging the SSD which is configured as boot device and installed operation system.

Surprise hot plug : The insertion of a SATA device into a backplane (combine signal and power) that has power present. The device powers up and initiates an OOB sequence.

Surprise hot removal: The removal of a SATA device from a powered backplane, without first being placed in a quiescent state.

2.14 NAND Flash Memory

Innodisk SATA Slim 3ME2 uses Multi Level Cell (MLC) NAND flash memory, which is non-volatility, high reliability and high speed memory storage.

3. Theory of Operation

3.1 Overview

Figure 2 shows the operation of Innodisk SATA Slim 3ME2 from the system level, including the major hardware blocks.

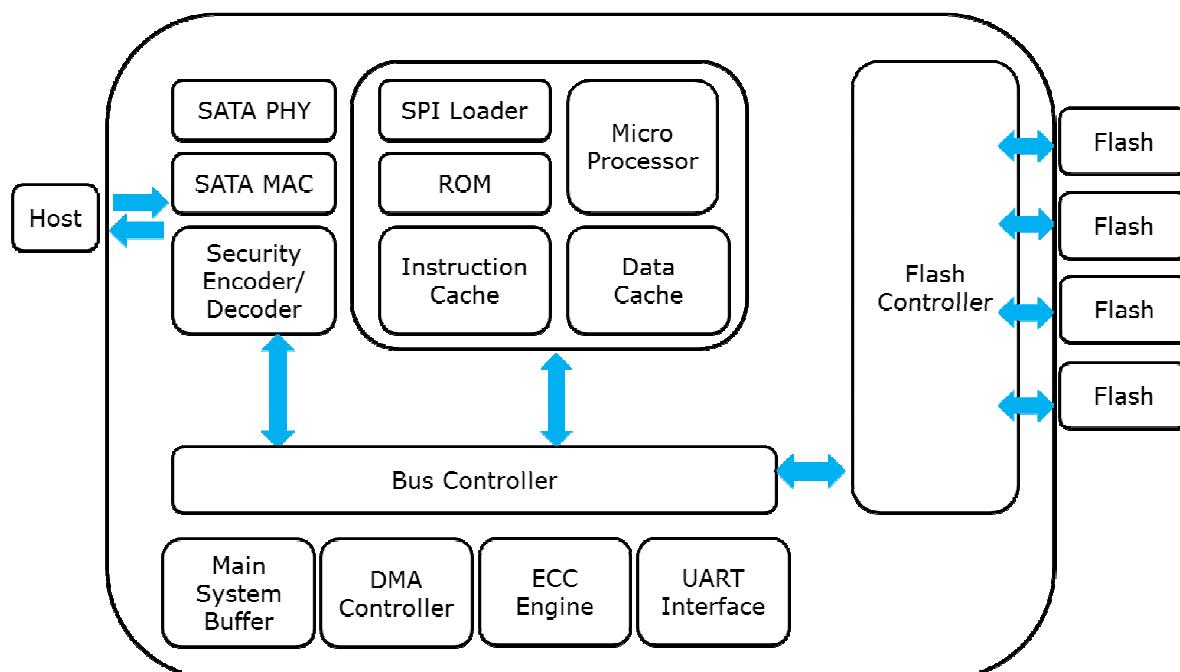


Figure 2: Innodisk SATA Slim 3ME2 Block Diagram

Innodisk 2 SATA Slim 3ME2 integrates a SATA III controller and NAND flash memories. Communication with the host occurs through the host interface, using the standard ATA protocol. Communication with the flash device(s) occurs through the flash interface.

3.2 SATA III Controller

Innodisk SATA Slim 3ME2 is designed with ID 202, a SATA III 6.0Gbps (Gen. 3) controller. The Serial ATA physical, link and transport layers are compliant with Serial ATA Gen 1, Gen 2 and Gen 3 specification (Gen 3 supports 1.5Gbps/3.0Gbps/6.0Gbps data rate). The controller has 4 channels for flash interface.

3.3 Error Detection and Correction

Highly sophisticated Error Correction Code algorithms are implemented. The ECC unit consists of the Parity Unit (parity-byte generation) and the Syndrome Unit (syndrome-byte computation). This unit implements an algorithm that can correct 66 bits per 1024 bytes in an ECC block. Code-byte generation during write operations, as well as error detection during read operation, is implemented on the fly without any speed penalties.

3.4 Wear-Leveling

Flash memory can be erased within a limited number of times. This number is called the **erase cycle limit** or **write endurance limit** and is defined by the flash array vendor. The erase cycle limit applies to each individual erase block in the flash device.

Innodisk SATA Slim 3ME2 uses a static wear-leveling algorithm to ensure that consecutive writes of a specific sector are not written physically to the same page/block in the flash. This spreads flash media usage evenly across all pages, thereby extending flash lifetime.

3.5 Bad Blocks Management

Bad Blocks are blocks that contain one or more invalid bits whose reliability are not guaranteed. The Bad Blocks may be presented while the SSD is shipped, or may develop during the life time of the SSD. When the Bad Blocks is detected, it will be flagged, and not be used anymore. The SSD implement Bad Blocks management, Bad Blocks replacement, Error Correct Code to avoid data error occurred. The functions will be enabled automatically to transfer data from Bad Blocks to spare blocks, and correct error bit.

3.6 iData Guard

Innodisk's iData Guard is a comprehensive data protection mechanism that functions before and after a sudden power outage to SSD. Low-power detection terminates data writing before an abnormal power-off, while table-remapping after power-on deletes corrupt data and maintains data integrity. Innodisk's iData Guard provides effective power cycling management, preventing data stored in flash from degrading with use.

3.7 Garbage Collection/TRIM

Garbage collection and TRIM technology is used to maintain data consistency and perform continual data cleansing on SSDs. It runs as a background process, freeing up valuable controller resources while sorting good data into available blocks, and deleting bad blocks. It also significantly reduces write operations to the drive, thereby increasing the SSD's speed and lifespan.

4. Installation Requirements

4.1 SATA Slim 3ME2 Pin Directions

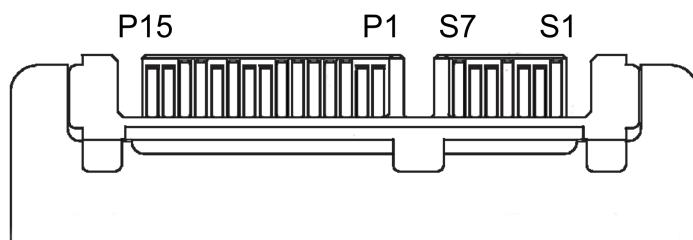


Figure 3: Signal Segment and Power Segment

4.2 Electrical Connections for SATA Slim 3ME2

A Serial ATA device may be either directly connected to a host or connected to a host through a cable. For connection via cable, the cable should be no longer than 1meter. The SATA interface has a separate connector for the power supply. Please refer to the pin description for further details.

4.3 Device Drive

No additional device drives are required. Innodisk SATA Slim 3ME2 can be configured as a boot device.

5. Part Number Rule

CODE	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20
	D	E	S	L	M	-	3	2	G	D	7	2	S	C	A	Q	N	-	X	X
Description	Disk	SATA Slim 3ME2					Capacity		Category			Flash Mode	Operation Temp.	Internal Control	CH.	Flash	-	Customized Code		

Definition

Code 1st (Disk)		Code 13th (Flash Mode)
D : Disk		S: Synchronous flash
		B: Toshiba 15nm Synchronous flash
Code 2nd ~ 5th (Form Factor)		Code 14th (Operation Temperature)
ESLM: SATA Slim 3ME2		C: Standard Grade (0°C ~ +70°C)
Code 7th ~9th (Capacity)		W: Industrial Grade (-40°C ~ +85°C)
8G: 8GB		Code 15th (Internal control)
16G: 16GB		1/A: PCB version
32G: 32GB		Code 16th (Channel of data transfer)
64G: 64GB		S: Single Channel
A28: 128GB		D: Dual Channels
B56: 256GB		Q: Quad Channels
Code 10th ~12th (Series)		Code 17th (Flash Type)
D72: ID202		N: Micron MLC
		C: Toshiba MLC
		Code 19th~20th (Customized Code)

Appendix

Certificate

Issue Date: March 11, 2015
Ref. Report No. ISL-15LE075CE

Product Name	:	SATA Slim
Model(s)	:	SATA Slim 3ME2 & (S:SLC,LiSLC,M:MLC) / *: Product line: (E:Embedded, G: EverGreen, R: InnoRobust) / #: controller: (empty:106/107/167/170, 2: 201/202, 3:108/109) / &: Product feature: (P: with DRAM, empty: without DRAM))
Responsible Party	:	Innodisk Corporation
Address	:	5F, No.237, Sec. 1, Datong Rd., Xizhi Dist., New Taipei City 221, Taiwan (R.O.C.)

We, International Standard Laboratory, hereby certify that:

The device bearing the trade name and model specified above has been shown to comply with the applicable technical standards as indicated in the measurement report and was tested in accordance with the measurement procedures specified in European Council Directive- EMC Directive 2004/108/EC. The device was passed the test performed according to :

Standards:

- EN 55022: 2010+AC2011 and CISPR 22: 2008 (modified)
- EN 61000-3-2: 2006+A1:2009+A2:2009 and IEC 61000-3-2: 2005+A1:2008+A2:2009
- EN 61000-3-3: 2013 and IEC 61000-3-3: 2013
- EN 55024: 2010 and CISPR 24: 2010
- EN 61000-4-2: 2009 and IEC 61000-4-2: 2008
- EN 61000-4-3: 2006+A1: 2008+A2: 2010 and
- IEC 61000-4-3:2006+A1: 2007+A2: 2010
- EN 61000-4-4:2012 and IEC 61000-4-4:2012

I attest to the accuracy of data and all measurements reported herein were performed by me or were made under my supervision and are correct to the best of my knowledge and belief. I assume full responsibility for the completeness of these measurements and vouch for the qualifications of all persons taking them.

International Standard Laboratory

Jim Chu / Director

<input type="checkbox"/> Hsi-Chih LAB: No. 65, Gu Dai Kang Street, Hsi-Chih Dist., New Taipei City 221, Taiwan Tel: 886-2-2646-2550; Fax: 886-2-2646-4641 Nemko ELA1138	<input checked="" type="checkbox"/> Lung-Tan LAB: No. 120, Lane 180, Hsin Ho Rd., Lung-Tan Dist., Tao Yuan City 325, Taiwan Tel: 886-3-407-1718; Fax: 886-3-407-1738 TAF ELA1138
--	---

Certificate

Issue Date: March 11, 2015
Ref. Report No. ISL-15LE075FB

Product Name : SATA Slim
Model(s) : SATA Slim 3S*-& (S:Flash type: (S:SLC,I:SLC,M:MLC) /
*: Product line: (E:Embedded, G: EverGreen, R: InnoRobust) /
#: controller: (empty:106/107/167/170, 2: 201/ 202, 3:108/109) /
& Product feature: (P: with DRAM, empty: without DRAM))
Applicant : Innodisk Corporation
Address : 5F No.237, Sec. 1, Datong Rd., Xizhi Dist., New Taipei City 221,
Taiwan (R.O.C.)

We, International Standards Laboratory, hereby certify that:

The device bearing the trade name and model specified above has been shown to comply with the applicable technical standards as indicated in the measurement report and was tested in accordance with the measurement procedures specified. (refer to Test Report if any modifications were made for compliance).



Standards:

FCC CFR Title 47 Part 15 Subpart B: 2012- Section 15.107 and 15.109
ANSI C63.4-2009

Industry Canada Interference-Causing Equipment Standard ICES-003 Issue 5: 2012

Class B

I attest to the accuracy of data and all measurements reported herein were performed by me or were made under my supervision and are correct to the best of my knowledge and belief. I assume full responsibility for the completeness of these measurements and vouch for the qualifications of all persons taking them.

International Standards Laboratory

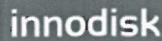
Jim Chu / Director

Hsi-Chih LAB:
No. 63, Gu Dai Kong Street, Hsi-Chih Dist.,
New Taipei City 221, Taiwan.
Tel: 886-2-2646-2530; Fax: 886-2-2646-4641



Lung-Tan LAB:
No. 120, Lane 180, Hsin Ho Rd., Lung-Tan Dist.,
Tao Yuan City 325, Taiwan
Tel: 886-3-407-1718; Fax: 886-3407-1738





宣鼎國際股份有限公司
Innodisk Corporation

Page 1/1

Tel:(02)7703-3000 Fax:(02) 7703-3555 Internet: http://www.innodisk.com/

RoHS 自我宣告書(RoHS Declaration of Conformity)

Manufacturer Product: All Innodisk EM Flash and Dram products

一、 宜鼎國際股份有限公司（以下稱本公司）特此保證售予新漢股份有限公司之所有產品，皆符合歐盟 2011/65/EU 關於 RoHS 之規範要求。

Innodisk Corporation declares that all products sold to Nexcom, are complied with European Union RoHS Directive (2011/65/EU) requirement.

二、 本公司同意因本保證書或與本保證書相關事宜有所爭議時，雙方宜友好協商，達成協議。

Innodisk Corporation agrees that both parties shall settle any dispute arising from or in connection with this Declaration of Conformity by friendly negotiations.

Name of hazardous substance	Limited of RoHS ppm (mg/kg)
鉛 (Pb)	< 1000 ppm
汞 (Hg)	< 1000 ppm
鎘 (Cd)	< 100 ppm
六價鉻 (Cr 6+)	< 1000 ppm
多溴聯苯 (PBBS)	< 1000 ppm
多溴二苯醚 (PBDEs)	< 1000 ppm

立 保 證 書 人 (Guarantor)

Company name 公司名稱 : Innodisk Corporation 宜鼎國際股份有限公司



Company Representative 公司代表人 : Randy Chien 簡川勝



Company Representative Title 公司代表人職稱 : Chairman 董事長

Date 日期 : 2016 / 08 / 04



宜鼎國際股份有限公司
Innodisk Corporation

Tel:(02)7703-3000 Fax:(02) 7703-3555 Internet: http://www.innodisk.com/

REACH Declaration of Conformity

Manufacturer Product: All Innodisk EM Flash and Dram products

1. 宜鼎國際股份有限公司（以下稱本公司）特此保證此售予貴公司之產品，皆符合歐盟化學品法案(Registration , Evaluation and Authorization of Chemicals ; REACH)之規定
(<http://www.echa.europa.eu/de/candidate-list-table> **last updated: 20/06/2016**)。所提供之產品包含：(1) 產品或產品所使用到的所有原物料；(2)包裝材料；(3)設計、生產及重工過程中所使用到的所有原物料。

We Innodisk Corporation hereby declare that our products are in compliance with the requirements according to the REACH Regulation
(<http://www.echa.europa.eu/de/candidate-list-table> **last updated: 20/06/2016**).
Products include : 1) Product and raw material used by the product ; 2) Packaging material ; 3) Raw material used in the process of design, production and rework

2. 本公司同意因本保證書或與本保證書相關事宜有所爭議時，雙方宜友好協商，達成協議。
InnoDisk Corporation agrees that both parties shall settle any dispute arising from or in connection with this Declaration of Conformity by friendly negotiations.

立 保 證 書 人 (Guarantor)

Company name 公司名稱：InnoDisk Corporation 宜鼎國際股份有限公司

Company Representative 公司代表人：Randy Chien 簡川勝

Company Representative Title 公司代表人職稱：Chairman 董事長

Date 日期：2016 / 06 / 23

